Low Distortion Internally Matched Power GaAs FETs (C-Band)

Features

- Low intermodulation distortion
 - $IM_3 = -45 \text{ dBc}$ at Po = 28 dBm,
 - Single carrier level
- High power
 - P_{1dB} = 39 dBm at 4.4 GHz to 5.0 GHz
- High gain
 - $G_{1dB} = 8.5 dB$ at 4.4 GHz to 5.0 GHz
- Broad band internally matched
- Hermetically sealed package

RF Performance Specifications (Ta = 25° C)

Characteristics	Symbol	Condition	Unit	Min.	Тур.	Max
Output Power at 1dB Compression Point	P _{1dB}		dBm	38.0	39.0	_
Power Gain at 1dB Compression Point	G _{1dB}	V _{DS} = 10V f = 4.4 ~ 5.0 GHz	dB	7.5	8.5	_
Drain Current	I _{DS1}		А	_	2.2	2.8
Gain Flatness	ΔG		dB	_	_	±0.6
Power Added Efficiency	η _{add}		%	_	31	_
3rd Order Intermodulation Distortion	IM ₃	Note 1	dBc	-42	-45	_
Drain Current	I _{DS2}	Note i	Α	_	2.2	2.8
Channel-Temperature Rise	ΔT_{ch}	$V_{DS}xI_{DS}xR_{th}(c-c)$	°C	_	_	80

Electrical Characteristics (Ta = 25° C)

Characteristic	Symbol	Condition	Unit	Min.	Тур.	Max
Trans-conductance	gm	$V_{DS} = 3V$ $I_{DS} = 3.0A$	mS	_	1800	_
Pinch-off Voltage	V_{GSoff}	$V_{DS} = 3V$ $I_{DS} = 40 \text{mA}$	V	-2	-3.5	-5.0
Saturated Drain Current	I _{DSS}	$V_{DS} = 3V$ $V_{GS} = 0V$	А	_	5.8	7.5
Gate-Source Breakdown Voltage	V _{GSO}	$I_{GS} = -120\mu A$	V	-5	-	-
Thermal Resistance	R _{th (c-c)}	Channel to case	°C/W	_	2.3	3.5

Note 1: 2 tone Test Pout = 28dBm Single Carrier Level.

The information contained here is subject to change without notice.

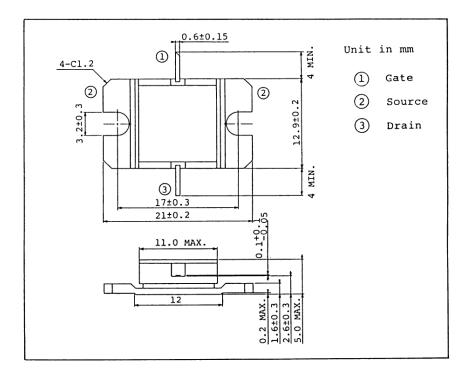
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Absolute Maximum Ratings (Ta = 25° C)

Characteristic	Symbol	Unit	Rating
Drain-Source Voltage	V _{DS}	V	15
Gate-Source Voltage	V _{GS}	V	-5
Drain Current	I _{DS}	А	8
Total Power Dissipation (T _c = 25°C)	P _T	W	37.5
Channel Temperature	T _{ch}	°C	175
Storage Temperature	T _{stg}	°C	-65~175

Package Outline (2-11D1B)

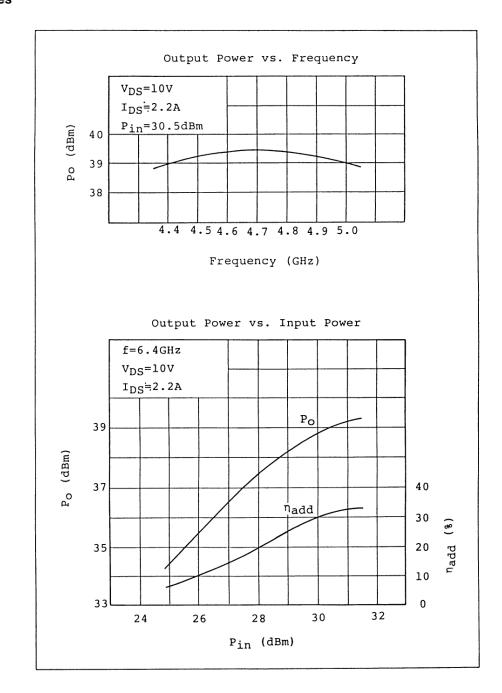


Handling Precautions for Packaged Type

Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

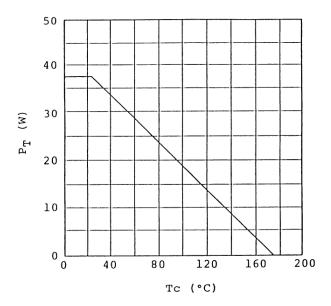
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RF Performances

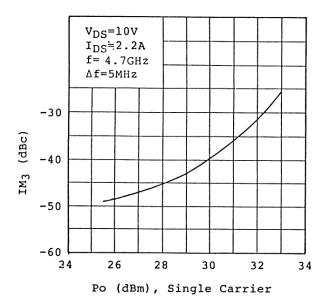


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Power Dissipation vs. Case Temperature



IM₃ vs. Output Power Characteristics



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TIM4450-8L S-Parameters (MAGN. and ANGLES)

 $V_{DS}=10V$, $I_{DS}=2.0A$

